

	SPECIFICAT	IONS						
CUSTOMER	: PT(	;						
SAMPLE CODE	: NS	NSC2002WRP-BWT-I						
MASS PRODUCTION CODE	: NP	C2002WRP-BWT	-1					
SAMPLE VERSION	<u>.</u> 01							
SPECIFICATIONS EDITION	. 001							
DRAWING NO. (Ver.)	: JLN	ID-NPC2002WR	P-BWT-I_001					
PACKAGING NO. (Ver.)	: JPI	G-NPC2002WR	P-BWT-I_001					
	Customer Ap	broved Date:	POWERTIP 2018.08.23 US RD APPROVED					
Approved	Checkee	k k	Designer					
閆偉	劉進		陳璐					
<ul> <li>Preliminary specification for design input</li> <li>Specification for sample approval</li> </ul>								
	POWERTIP TEC	I. CORP.						
Headquarters: No.8, 6 <sup>th</sup> Road, Taichung I Taichung, Taiwan 台中市 407 工業區六路 8	TEI FAλ	.: 886-4-2355-8168 (: 886-4-2355-8166	E-mail: <u>sales@powertip.com.tw</u> Http://www.powertip.com.tw					



# History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
08/08/2018	01	001	New Sample	-	陳璐
				Tota	al : 31 Pages



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Appendix A : LCM drawing Packaging

Note : For detailed information please refer to IC data sheet : SITRONIX---ST7066U-0T



#### **1. SPECIFICATIONS**

#### 1.1 Features

Item	Standard Value
Display Type	20*2 Characters
LCD Type	PBT , Negative , Transmissive
Driver Condition	LCD Module : 1/16 Duty , 1/5 Bias
Viewing Direction	6 O'clock
Weight	52.7g
Interface	6800-series 8-bit parallel
Driver IC	ST7066U
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web site :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

# **1.2 Mechanical Specifications**

Item	Standard Value	Unit
Outline Dimension	116.0 (L) * 37.0 (W) *13.3 (H)	mm
Viewing Area	85.0 (L) * 18.5 (W)	mm
Active Area	73.5 (L) * 11.5 (W)	mm
Character Size	3.2(L) * 5.55(W)	mm
Character Pitch	3.7(L) * 5.95(W)	mm

Note : For detailed information please refer to LCM drawing

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#### 1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	Vdd	-	-0.3	7.0	V
LCD Driver Supply Voltage	V <sub>LCD</sub>	-	VDD -10.0	VDD +0.3	V
Input Voltage	VIN	-	-0.3	V <sub>DD</sub> +0.3	V
Operating Temperature	T <sub>OP</sub>	-	-20	70	°C
Storage Temperature	T <sub>ST</sub>	-	-30	80	°C
Storage Humidity	H⊳	Ta<60 ℃	-	90	%RH

## **1.4 DC Electrical Characteristics**

					Ta =	<b>25°</b> ∁
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V <sub>DD</sub>	-	4.5	5.0	5.5	V
"H" Input Voltage	Vін	-	0.7 Vdd	_	Vdd	V
"L" Input Voltage	VIL		-0.3	-	0.6	V
"H" Output Voltage	Vон	IOH=-0.1mA	3.9	-	Vdd	V
"L" Output Voltage	Vol	IOL=0.1mA	-	-	0.4	V
Supply Current	IDD	V <sub>DD</sub> = 5.0 V ,Vo= 0.8 V *1	-	10	15	mA
		-20°C (Vdd= 5.0 V)	0.6	0.8	1.0	
LCM Driver Voltage	Vo	25°C (Vdd= 5.0 V)	0.6	0.8	1.0	V
		70°C (VDD= 5.0 V)	0.6	0.8	1.0	

NOTE: \*1 The Maximum current display



#### **1.5 Optical Characteristics**

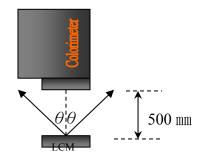
	LCD Panel :	1/16 Dut	ty,1/5 Bia	as , V <sub>LCD</sub> :	= 8.3 V,	Ta =25℃		
Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Response Time	Rise	tr		-	53	80	me	Note 2
Response nine	Fall	tf	-	-	33	50	ms	Note 2
	Тор	θ+		-	60	-		
Viewing angle	Bottom	θ-	C>2.0	-	60	-	Deg.	Note 1
range	Left	θL	C <u>&gt;</u> 2.0	-	60	-		Note 1
	Right	θR		-	60	-		
Contrast Ra	tio	С	-	-	124	-	-	Note 3
Average Bright (with LCD		IV		40	65	-	cd/m <sup>2</sup>	
Color of CIE Coordinate		Х	IF= 60 mA	0.20	0.25	0.30		Note 4
(With LCD	)	Y		0.24	0.29	0.34	-	
Uniformity		∆B		70	-	_	%	

Note 4 :

1 : △B=B(min) / B(max) \* 100%

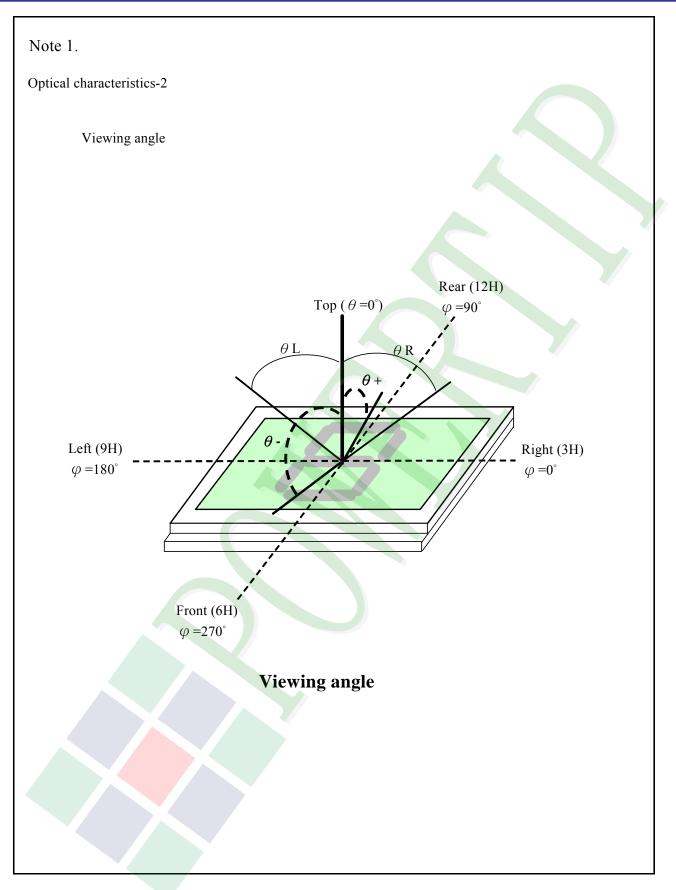
- 2: Measurement Condition for Optical Characteristics:
  - a : Environment: 25℃±5℃ / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance:  $500 \pm 50 \text{ mm} \rightarrow (\theta = 0^{\circ})$
  - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
  - d : The uncertainty of the C.I.E coordinate measurement  $\pm 0.01$ , Average Brightness  $\pm 4\%$



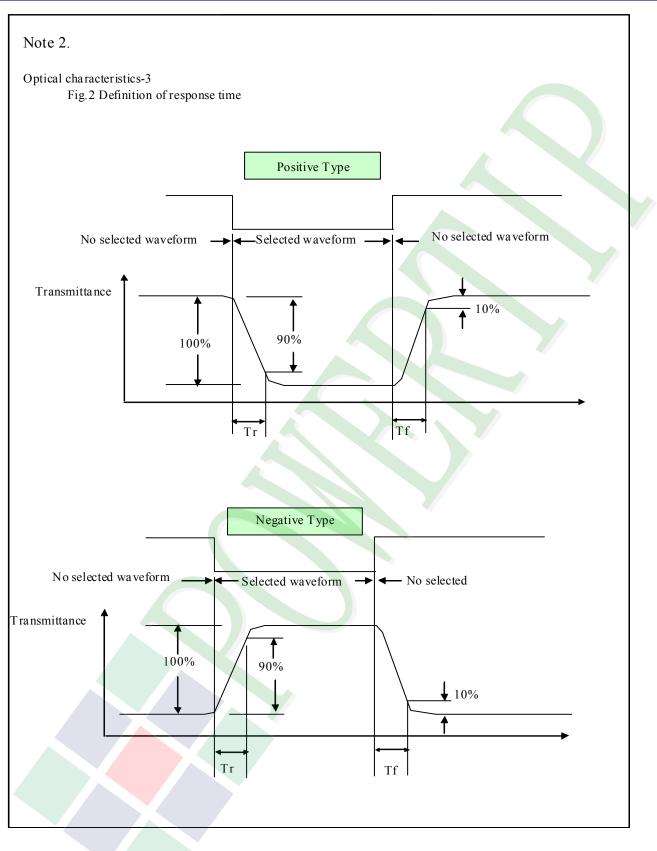


Colorimeter=BM-7 fast

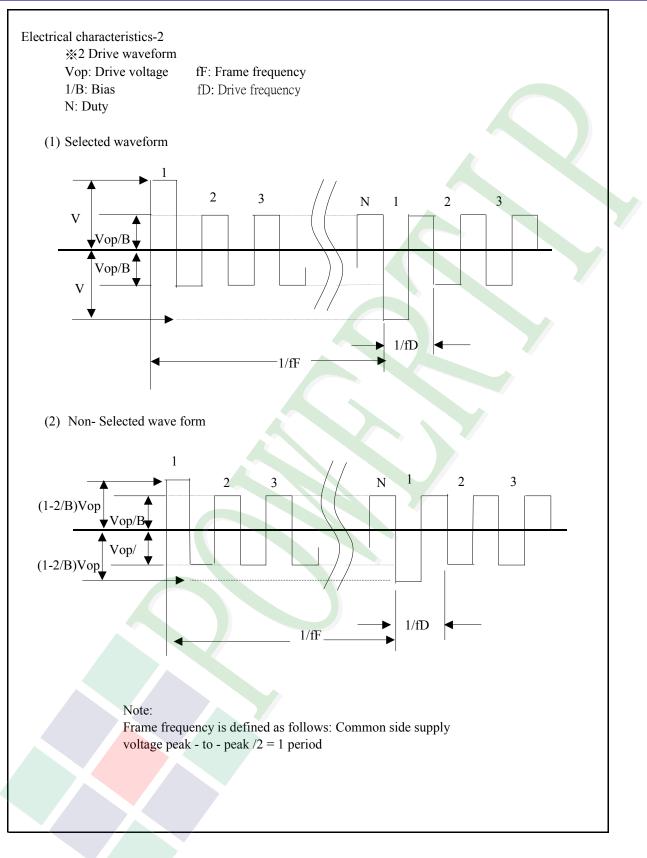




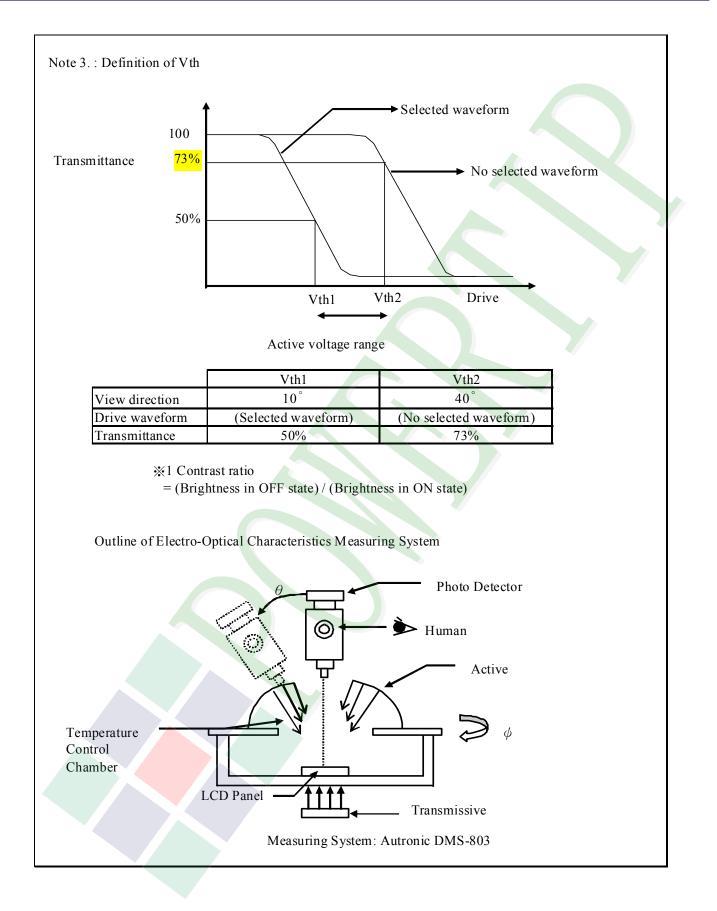














# **1.6 Backlight Characteristics**

#### Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	<b>Ta =25</b> ℃	-	180	mA
Reverse Voltage	VR	<b>Ta =25</b> ℃	-	5	V
Power Dissipation	PD	<b>Ta =25</b> ℃	-	630	mW

#### **Electrical / Optical Characteristics**

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF		3.1	3.3	3.5	V
Average Brightness (without LCD)	IV	IF= 60 mA	1400	1700	-	cd/m <sup>2</sup>
CIE Color Coordinate	Х		0.255	0.285	0.315	
(Without LCD)	Y		0.255	0.285	0.315	-
Color	White					

οK

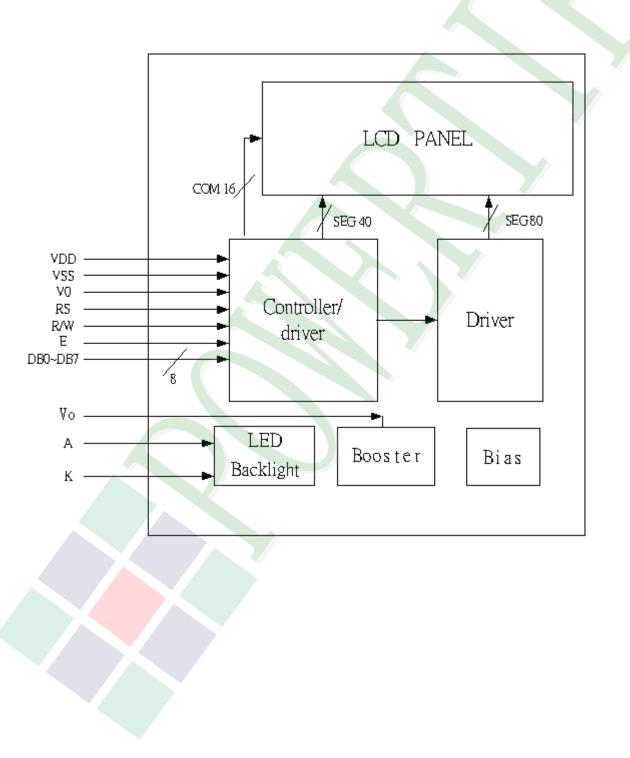


# 2. MODULE STRUCTURE

## 2.1 Counter Drawing

#### 2.1.1 LCM Mechanical Diagram

- \* See Appendix
- 2.1.2 Block Diagram





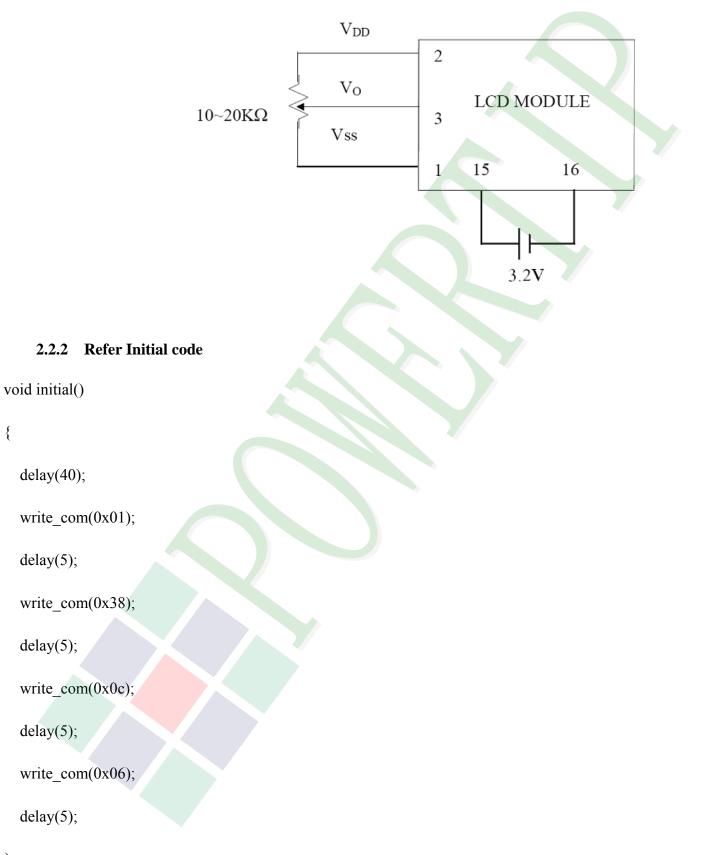
## 2.2 Interface Pin Description

Pin No.	Symbol	Signal Description			
1	Vss	Power Supply (Vss=0)			
2	V <sub>DD</sub>	Power Supply (5V)			
3	Vo	Operating voltage for LCD			
		Register Selection input			
4	RS	High = Data register			
4	K0	Low = Instruction register (for write)			
		Busy flag address counter (for read)			
5	R/W	Read/Write signal input is used to select the read/write mode			
5		High = Read mode, Low = Write mode			
6	E	Start enable signal to read or write the data			
7	DB0				
8	DB1	Four low order bi-directional three-state data bus lines. Use for			
9	DB2	data transfer between the MPU and the LCD module.			
10	DB3	These four are not used during 4-bit operation.			
11	DB4				
12	DB5	Four high order bi-directional three-state data bus lines. Used			
13	DB6	for data transfer between the MPU and the LCD module.			
14	DB7	DB7 can be used as a busy flag.			
15	А	LED+			
16	К	LED-			



#### 2.2.1 Application Notes

Contrast Adjust

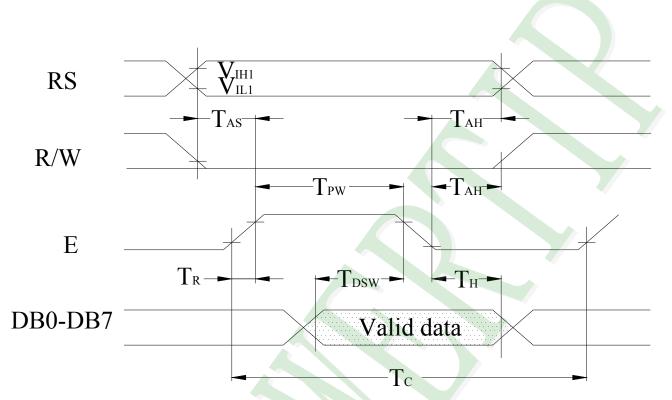




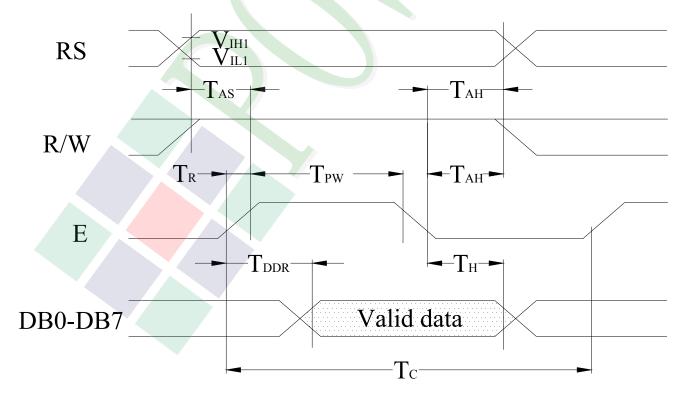


#### 2.3 Timing Characteristics

• Writing data from MPU to ST7066U



• Reading data from ST7066U to MPU





• Write Mode (Writing data from MPU to ST7066U)

				(\	/DD = 5V,	Ta=25°C)
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Tc	Enable Cycle Time	Pin E	1200	-	ŀ	ns
T <sub>PW</sub>	Enable Pulse Width	Pin E	140	-	-	ns
$T_R$ , $T_F$	Enable Rise / Fall Time	Pin E	-	- (	25	ns
Tas	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
Тан	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
Tosw	Data Setup Time	Pins:DB0~DB7	40	-	-	ns
Тн	Data Hold Time	Pins:DB0~DB7	10	I	-	ns

Read Mode (Reading data from ST7066U to MPU)

					VDD = 5\	/,Ta=25°C)
Symbol	Characteristics	Test Condition	Min.	Тур.	Max.	Unit
Tc	Enable Cycle Time	Pin E	1200	-	-	ns
TPW	Enable Pulse Width	Pin E	140	-	-	ns
T <sub>R</sub> , T <sub>F</sub>	Enable Rise / Fall Time	Pin E	-	-	25	ns
Tas	Address Setup Time	Pins: RS , RW,E	0	-	-	ns
Тан	Address Hold Time	Pins :RS,RW,E	10	-	-	ns
T <sub>DDR</sub>	Data Setup Time	Pins:DB0~DB7	-	-	100	ns
Тн	Data Hold Time	Pins:DB0~DB7	10	-	-	ns

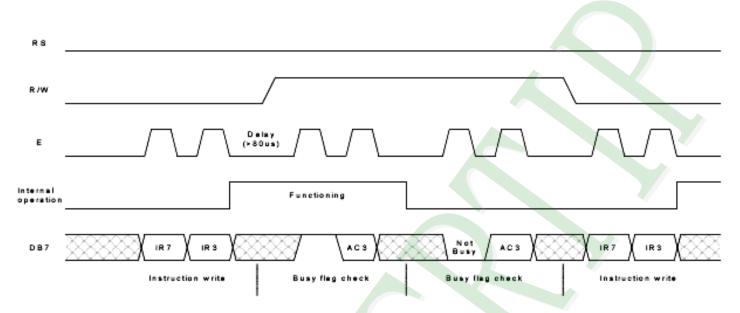
\_\_\_\_\_

NPC2002WRP-BWT-I

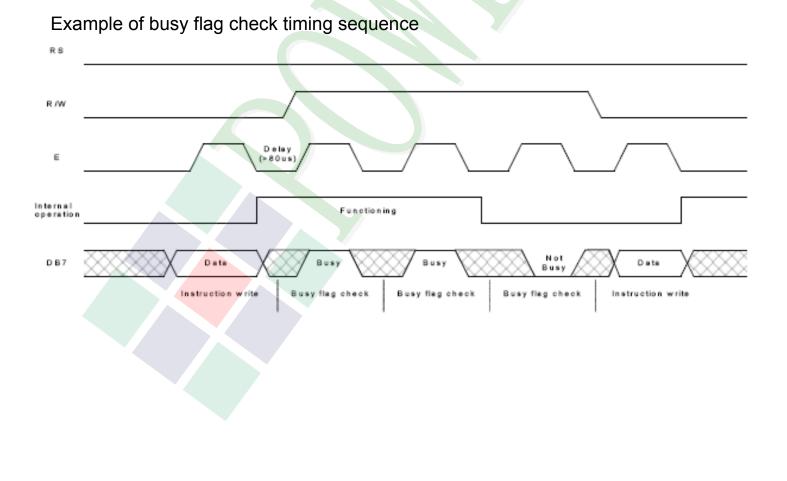


For 4-bit interface date, only four bus lines (DB4 to DB7) are used for transfer.

Example of busy flag check timing sequence



For 8-bit interface date, all eight bus lines (DB0 to DB7) are used .





# 2.4 Display Command

	Instruction Code						Description					
Instructions	RS	R/ W	DB 7	DB 6	DB 5	DB 4	DB 3	DB 2	DB 1	DB 0	Description	Time (270KHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM. and set DDRAM address to "00H" from AC.	1.52ms
Return Home	0	0	0	0	0	0	0	0	1	×	Set DDRAM address to "00H" from AC and return cursor to it's original position if shifted. The contents of DDRAM are not changed.	1.52ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	S	Sets cursor move direction and specifies display shift. These operations are performed during data write and read.	37µs
Display ON/OFF	0	0	0	0	0	0	1	D	С	В	D=1 : entire display on C=1 : cursor on B=1 : cursor position on	37µs
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	×	×	Set cursor moving and display shift control bit, and the the direction, without changing of DDRAM data.	37µs
Function Set	0	0	0	0	1	DL	N	F	×	×	DL: interface data is 8/4 bits NL: number of line is 2/1 F: font size is 5×11/5×8	37µs
Set CGRAM Address	0	0	0	1	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Set CGRAM address in address counter.	37µs
Set DDRAM Address	0	0	1	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Set DDRAM address in address counter.	37µs
Read Busy Flag and Address	0	1	B F	AC 6	AC 5	AC 4	AC 3	AC 2	AC 1	AC 0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0µs



Write Data	1	0	D	D6	D5	D4	ЪЗ	2		D0	Write data into internal RAM	<b>37</b> μ <b>s</b>
to RAM	I	0	7	00	05	D4	03	DZ	וט	DU	(DDRAM/CGRAM).	57µ5
Read Data	1	1	D	D6	DE	Π4	2	50			Read data from internal RAM	270
from RAM	I	I	7	D0	D5	D4	50	DZ	וט	D0	(DDRAM/CGRAM).	37μ <b>s</b>

Note:

Be sure the ST7066U is not in the busy state (BF=0) before sending an instruction from the MPU to the ST7066.

If an instruction is sent without checking the busy flag, the time between the first instruction and next instruction will take much longer than the instruction time itself.

Before checking BF, be sure to wait at least 80us.. Do not keep "E" always "High" for checking BF Refer to Instruction Table for the list of each instruction execution time .



# 2.5 Character Pattern

ST7066-0T

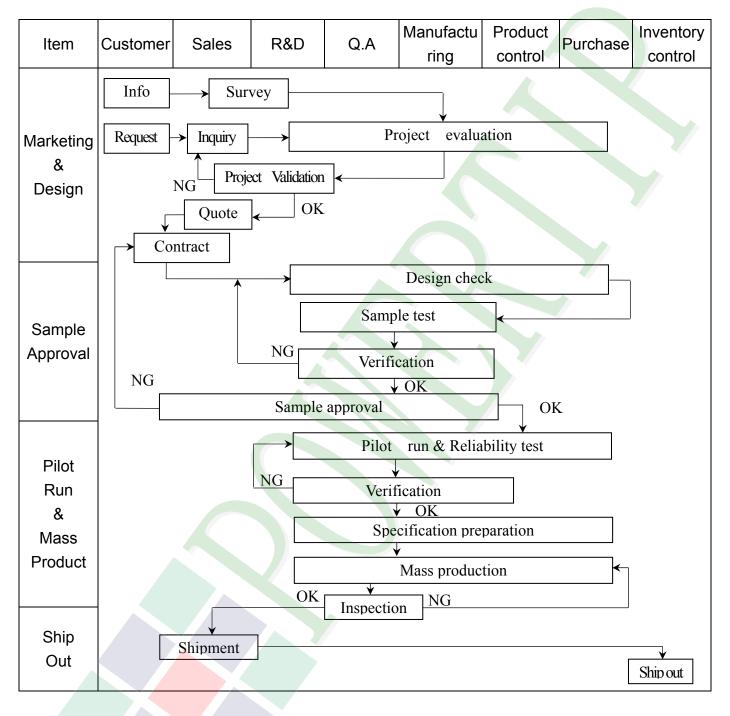
<u>b7-b4</u> b3-b0	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
0000	CG RAM (1)															
0001	(2)															
0010	(3)										Ê	6				
0011	(4)		#								Ж					
0100	(5)														٠	
0101	(6)															
0110	Ø		88								Ø	8				
0111	(8)															
1000	(1)			8												
1001	(2)										X	Ő.				
1010	(3)										۵		•••			
1011	(4)															
1100	(5)											M				
1101	(6)		••••								Ь	н	ċ.			8
1110	7)										Ы					
1111	(8)												ŧ.			

2.6 JUMPER (Setting different use) J1,J3,J5,JM,JF



# **3. QUALITY ASSURANCE SYSTEM**

## 3.1 Quality Assurance Flow Chart





Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control
Sales Service	Info Analy:	→ Claim -	[	Trackin	Failure an Corrective	_		
Q.A Activity	1. ISO 900 3. Equipme 5. Standard	ent calibrat	ion	4	Process in . Education			es

# POWERTIP

## 3.2 Inspection Specification

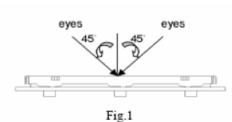
Scope : The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).

igoplusInspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level  $I\!I$  .

- ◆Equipment : Gauge、MIL-STD、Powertip Tester、Sample
- ◆Defect Level : Major Defect AQL : 0.4 ; Minor Defect : AQL : 1.5.
- ♦OUT Going Defect Level : Sampling .

#### ◆Manner of appearance test :

- (1). The test be under  $20W \times 2$  fluorescent light ' and distance of view must be at 30 cm.
- (2). Standard of inspection : (Unit : mm)
- (3). The test direction is base on about around  $45^{\circ}$  of vertical line. (Fig. 1)
- (4). Definition of area . (Fig. 2)





A area : viewing area

Fig. 2

Specification:

NO	Item	Criterion	Level				
		1. 1 The part number is inconsistent with work order of Production.	Major				
01	Product condition	1. 2 Mixed production types.					
		1.3 Assembled in inverse direction.	Major				
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major				
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major				
		4. 1 Missing line character and icon.	Major				
		4. 2 No function or no display.	Major				
04	Electrical Testing	4, 3 Output data is error.	Major				
		4, 4 LCD viewing angle defect.	Major				
		4.5 Current consumption exceeds product specifications.	Major				

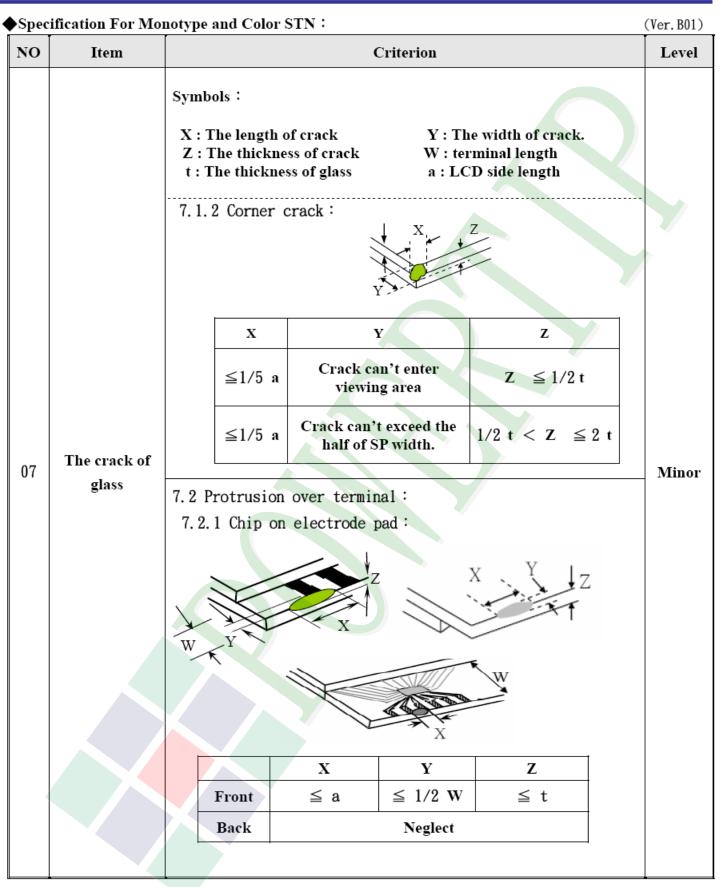


♦Spe	cification For Mono	otype and Color STN:				(1	Ver.B01)
NO	Item	C	riteri	on			Level
	Black or white dot 、scratch 、 contamination	<ul> <li>5. 1 Round type:</li> <li>5. 1. 1 display only :</li> <li>• White and black spots on 4 white or black spots pr</li> <li>• Densely spaced : NO more</li> <li>5. 1. 2 Non-display :</li> </ul>	esent.				
		Dimension		Accentance	( <b>O</b> 't	v)	
	Round type	(diameter : $\Phi$ )		Acceptance (Q <sup>2</sup> A area			
	st la	$\Phi \leq 0.10$		ept no dense		arca	
		$0.10 < \Phi \leq 0.20$		3			
05	<b>₩</b>	$0.20 < \Phi \leq 0.30$		2	I	gnore	Minor
	Φ=(x+y)/2	Total quantity	4				
	Line type $\downarrow W$ $\downarrow W$ $\downarrow W$ $\downarrow W$	5. 1. 3 Line type:DimensionLength (L)Width (W)W $\leq 0$ L $\leq 3.0$ 0. 03 < W $\leq 0$ L $\leq 3.0$ 0. 05 < W $\leq 0$	). 03 ). 05	Accep A area Accept no de 4		e (Q'ty) B area Ignore	
		$  L \le 2.5  0.05 < W \le 0. $		As	roun	d type	
				1			
		Dimension		Acceptan	ce (Q	'ty)	
		(diameter : Φ)		A area		B area	
		Φ ≤ 0.20	Ac	cept no dense			
06	Polarizer	$0.20 < \Phi \leq 0.50$		3			Minor
	Bubble	$0.50 < \Phi \le 1.00$	2			Ignore	TATHOL.
		$\Phi > 1.00$		0			
		Total quantity		4			

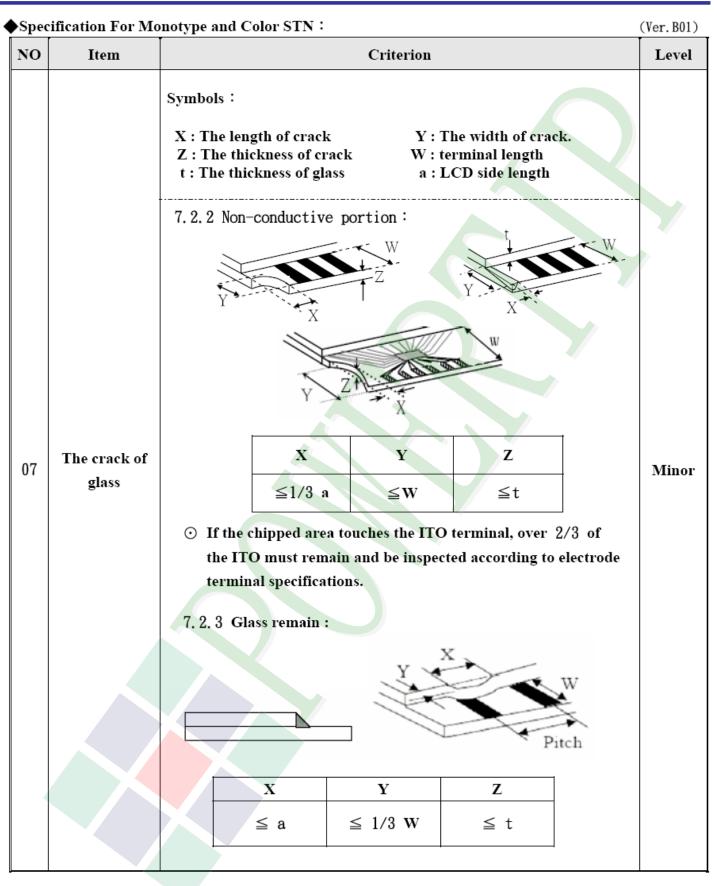


◆Specification For Monotype and Color STN: (Ver. I							
NO	Item	Criterio	n	Level			
		Z : The thickness of crack W	2 : The width of crack. V : terminal length 1 : LCD side length				
		7.1 General glass chip: 7.1.1 Chip on panel surface and cra	ck between panels:				
07	The crack of glass			Minor			
		[OK] Seal width	X Y				
		X Y	Z				
		≤ a Crack can't enter viewing area	$\leq 1/2 t$				
		≤ a Crack can't exceed th half of SP width.	$\frac{1}{2} t < \mathbf{Z} \leq t$				











<b>♦</b> Speci	ification For Mo	notype and Color STN:	(Ver.B01)
NO	Item	Criterion	Level
		8. 1 Backlight can't work normally.	Major
08	Backlight elements	8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
		9. 1 Pin type must match type in specification sheet.	Major
		9. 2 No short circuits in components on PCB or FPC.	Major
09	General appearance	9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor
		9.5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1.5 mm.	Minor



## **4. RELIABILITY TEST**

4.1	<b>Reliability Test Co</b>	ndition (Ver.B01)					
NO.	<b>TEST ITEM</b>	TEST CONDITION					
1	High Temperature Storage Test	Keep in +80 ±2°C 240hrs Surrounding temperature, then storage at normal condition 4hrs.					
2	Low Temperature Storage Test	Keep in $-30 \pm 2^{\circ}$ C 240hrs Surrounding temperature, then storage at normal condition 4hrs.					
3	High Temperature / High Humidity Storage Test	Keep in +60 °C / 90% R.H duration for 240hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)					
4	Temperature Cycling Storage Test	$\begin{array}{cccc} -30^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \rightarrow +80^{\circ}\text{C} \rightarrow +25^{\circ}\text{C} \\ (30\text{mins}) & (5\text{mins}) & (30\text{mins}) & (5\text{mins}) \\ \hline & & & & \\ & & & & \\ & & & & \\ & & & &$					
5	ESD Test	Air Discharge:Contact Discharge:Apply 2 KV with 5 timesApply 250 V with 5 timesDischarge for each polarity +/-discharge for each polarity +/-1. Temperature ambiance : 15°C ~35°C2. Humidity relative : 30%~60%3. Energy Storage Capacitance(Cs+Cd) : 150pF±10%4. Discharge Resistance(Rd) : 330 Ω±10%5. Discharge, mode of operation :Single Discharge (time between successive discharges at least 1 sec)(Tolerance if the output voltage indication : ±5%)					
6	Vibration Test (Packaged)	<ol> <li>Sine wave 10~55 Hz frequency (1 min/sweep)</li> <li>The amplitude of vibration :1.5 mm</li> <li>Each direction (X \ Y \ Z) duration for 2 Hrs</li> </ol>					
7	Drop Test (Packaged)	Packing Weight (Kg)         Drop Height (cm)           0 ~ 45.4         122           45.4 ~ 90.8         76           90.8 ~ 454         61           Over 454         46					
		Drop Direction : ※1 corner / 3 edges / 6 sides each 1time					

# **POWERTIP**

# 5. PRECAUTION RELATING PRODUCT HANDLING

## 5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

## 5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands , this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320\pm10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .
- 5.2.10 Caution!( LCM products with Capacitive Touch Panel) Strong EMI-sources such as switch-mode power supplies (SMPS) can lead to touch malfunction (e.g. ghost-touches).

Therefore, the touch needs to be thoroughly tested inside the target application.

## 5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}C \pm 5^{\circ}C$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

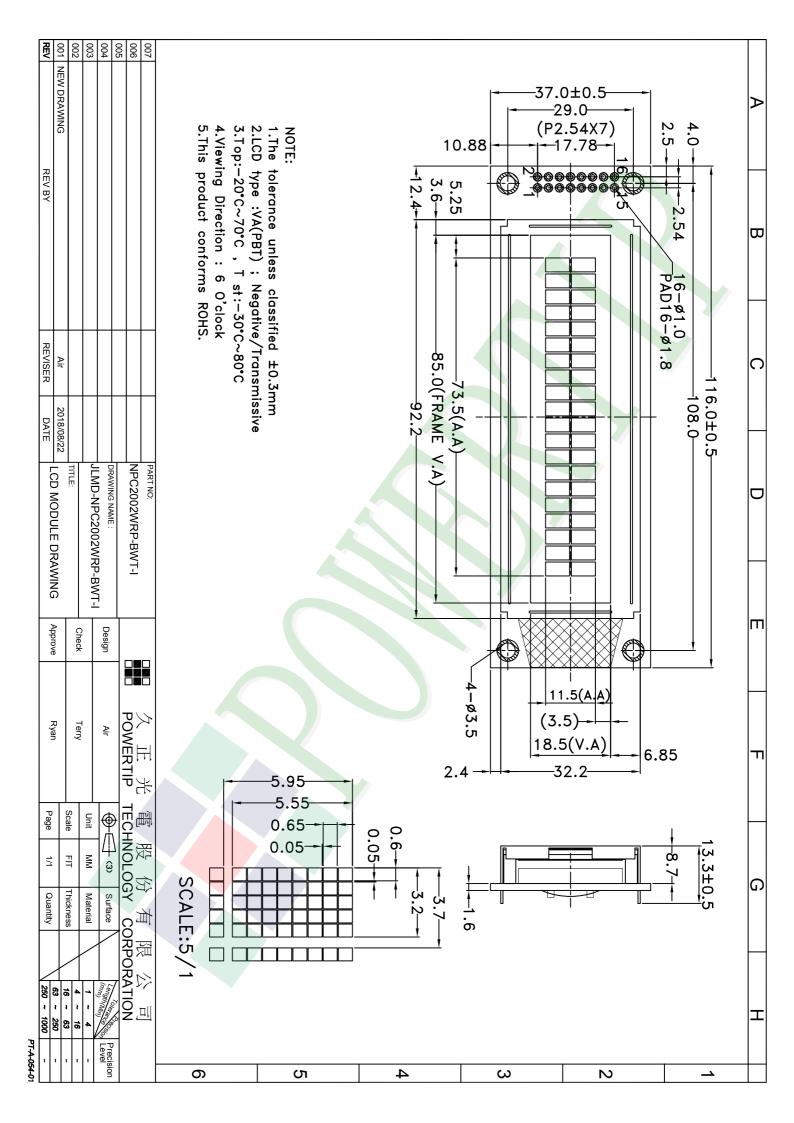
#### **5.4 TERMS OF WARRANTY**

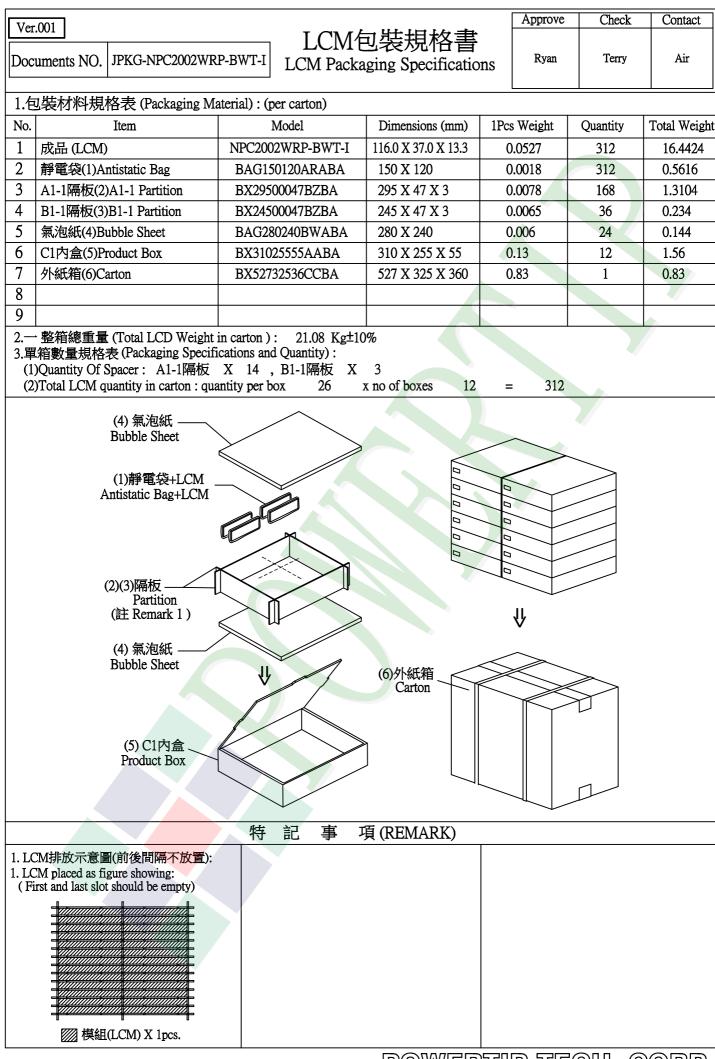
- 5.4.1 Applicable warrant period The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security



systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.





POWERTIP TECH. CORP.